

TSA60R070SFD

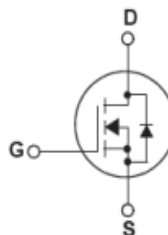
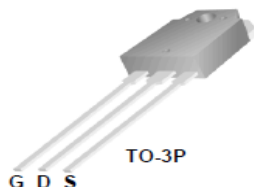
600V 47A N-Channel SJ-MOSFET

General Description

Truesemi SJ-FET is new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance.

This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy.

SJ-FET is suitable for various AC/DC power conversion in switching mode operation for higher efficiency.



Features

- Fast-Recovery body diode
- Extremely Low Reverse Recovery Charge
- 650V @T_J = 150 °C
- Typ. R_{DS(on)} = 60mΩ
- Ultra Low gate charge (typ. Q_g = 170nC)
- 100% avalanche tested

Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V _{DSS}	Drain-Source Voltage	600	V
I _D	Drain Current -Continuous (TC = 25°C) -Continuous (TC = 100°C)	47* 29*	A
I _{DM}	Drain Current – Pulsed (Note 1)	140	A
V _{GSS}	Gate-Source voltage	±30	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	1135	mJ
I _{AR}	Avalanche Current (Note 1)	9.3	A
E _{AR}	Repetitive Avalanche Energy (Note 1)	1.72	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	40	V/ns
dvds/dt	Drain Source voltage slope (V _{ds} =480V)	80	V/ns
P _D	Power Dissipation (TC = 25°C)	391	W
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C
T _L	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds	300	°C

* Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	Value	Unit
R _{θJC}	Thermal Resistance, Junction-to-Case	0.32	°C/W
R _{θCS}	Thermal Resistance, Case-to-Sink Typ.	0.5	°C/W
R _{θJA}	Thermal Resistance, Junction-to-Ambient	62	°C/W

Electrical Characteristics TC = 25 °C unless otherwise noted

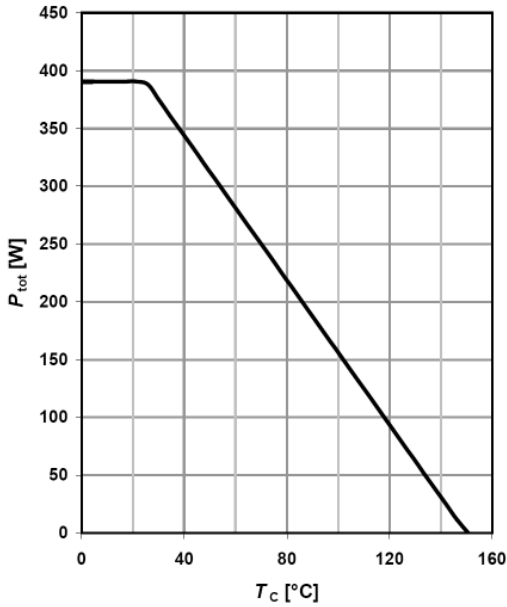
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Off Characteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V, I _D = 250μA, T _J = 25 °C	600	--	--	V
		V _{GS} = 0V, I _D = 250μA, T _J = 150 °C	--	650	--	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250μA, Referenced to 25 °C	--	0.6	--	V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 600V, V _{GS} = 0V, T _C = 25 °C	--	--	1	μA
		-T _C = 150 °C	--	--	10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30V, V _{DS} = 0V	--	--	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -30V, V _{DS} = 0V	--	--	-100	nA
On Characteristics						
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250μA	2.5	--	4.5	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = 10V, I _D = 23A	--	60	70	mΩ
g _{FS}	Forward Trans conductance	V _{DS} = 40V, I _D = 25A	--	30	--	S
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	--	3100	--	pF
C _{oss}	Output Capacitance		--	610	--	pF
C _{rss}	Reverse Transfer Capacitance		--	15	--	pF
t _{d(on)}	Turn-On Delay Time	V _{DD} = 480V, I _D = 23A R _G = 20Ω(Note 4)	--	16	--	ns
t _r	Turn-On Rise Time		--	12	--	ns
t _{d(off)}	Turn-Off Delay Time		--	83	--	ns
t _f	Turn-Off Fall Time		--	5	--	ns
Q _g	Total Gate Charge	V _{DS} = 480V, I _D = 23A V _{GS} = 10V (Note 4)	--	170	--	nC
Q _{gs}	Gate-Source Charge		--	21	--	nC
Q _{gd}	Gate-Drain Charge		--	87	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I _S	Maximum Continuous Drain-Source Diode Forward Current		--	--	47	A
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	140	A
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0V, I _F = 23A	--	0.9	1.5	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0V, I _F = 23A di _F /dt = 100A/μs	--	230	--	ns
Q _{rr}	Reverse Recovery Charge		--	3	--	μC
I _{rrm}	Peak Reverse Recovery Current		--	23	--	A

NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. I_{AS}=9.3A, V_{DD}=50V, Starting T_J=25 °C
3. I_{SD}≤23A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25 °C
4. Essentially Independent of Operating Temperature Typical Characteristics

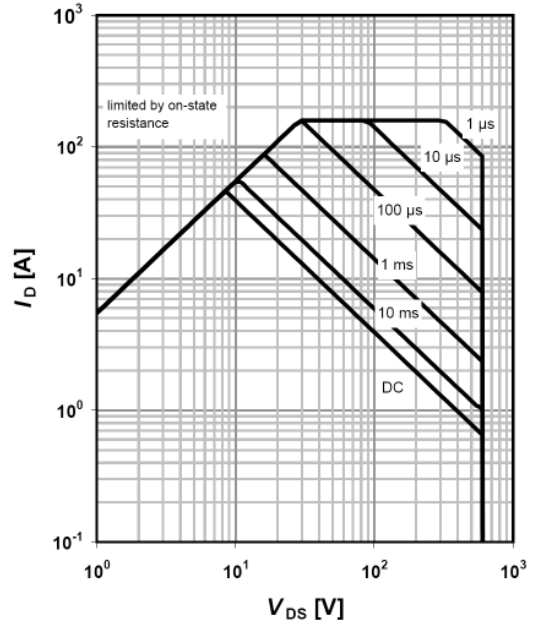
Typical Performance Characteristics

Power dissipation



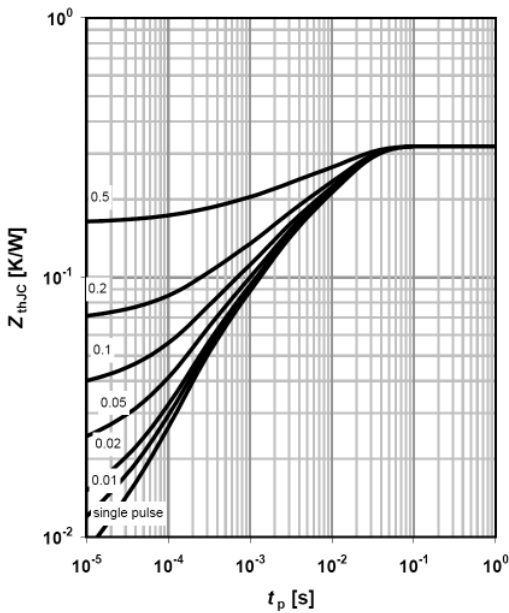
$$P_{tot} = f(T_C)$$

Safe operating area TC=25 °C



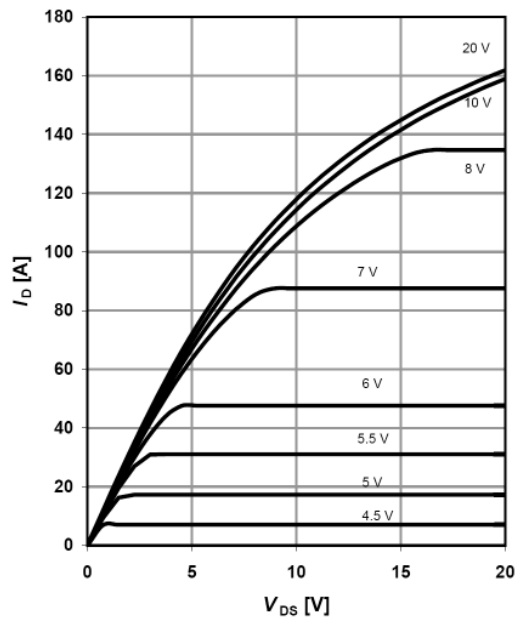
$$I_D = f(V_{DS}); T_C = 25 \text{ °C}; D = 0; \text{ parameter } t_p$$

Max. transient thermal impedance



$$Z_{(th)JC} = f(t_p); \text{ parameter } D = t_p/T$$

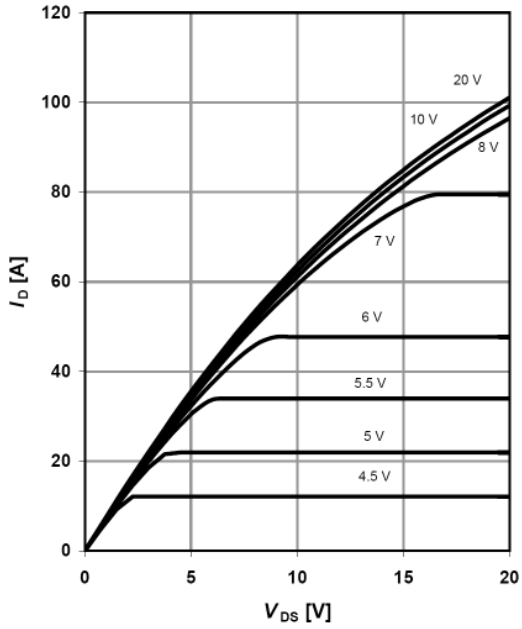
Typ. output characteristics $T_j = 25 \text{ °C}$



$$I_D = f(V_{DS}); T_j = 25 \text{ °C}; \text{ parameter: } V_{GS}$$

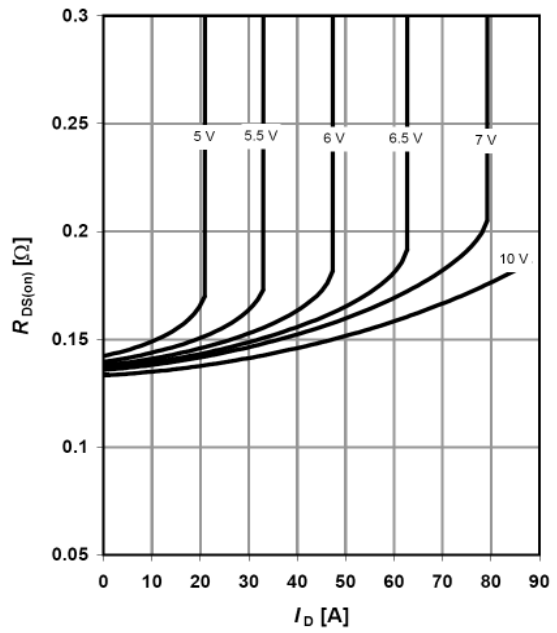
Typical Performance Characteristics

Typ. output characteristics $T_j=125\text{ }^\circ\text{C}$



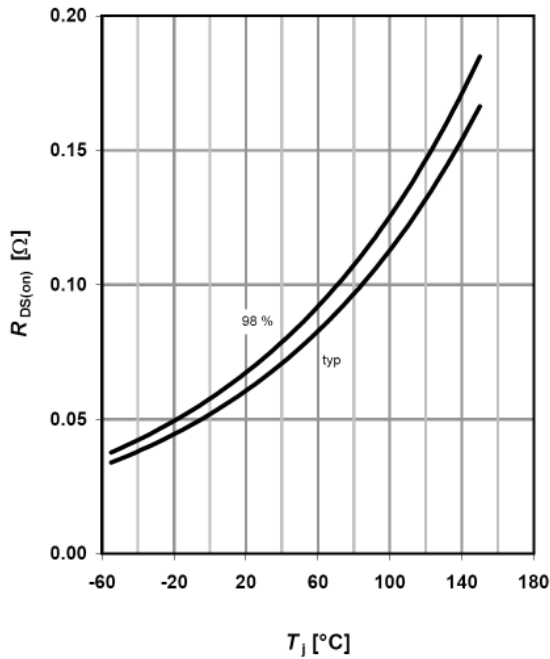
$I_D = f(V_{DS}); T_j = 125\text{ }^\circ\text{C}$; parameter: V_{GS}

Typ. drain-source on-state resistance



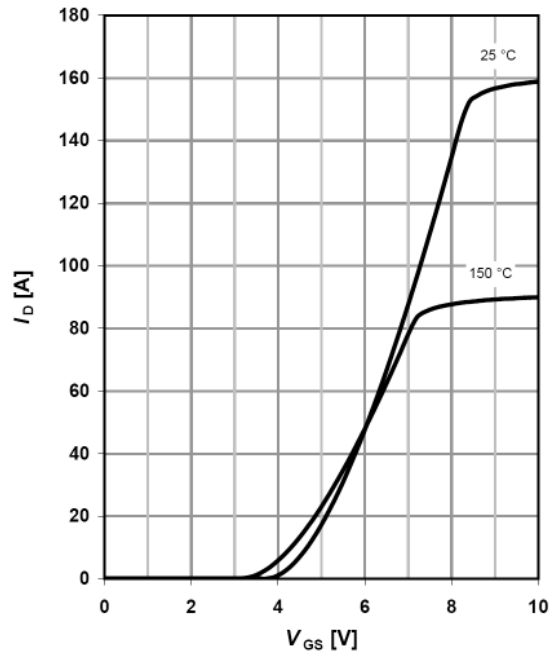
$R_{DS(on)} = f(I_D); T_j = 125\text{ }^\circ\text{C}$; parameter: V_{GS}

Typ. drain-source on-state resistance



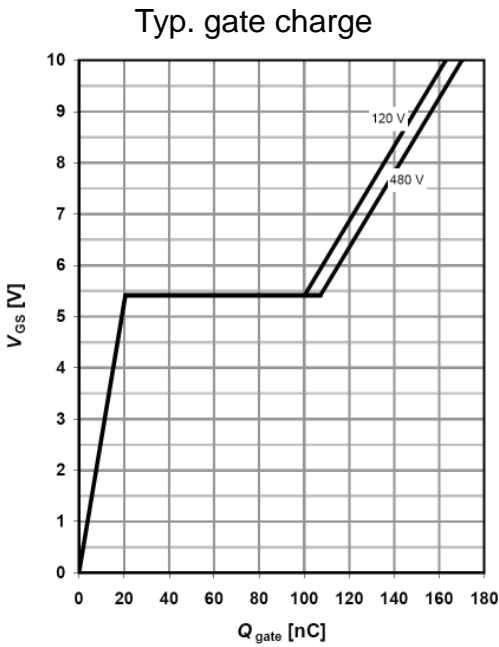
$R_{DS(on)} = f(T_j); I_D = 23\text{ A}; V_{GS} = 10\text{ V}$

Typ. transfer characteristics

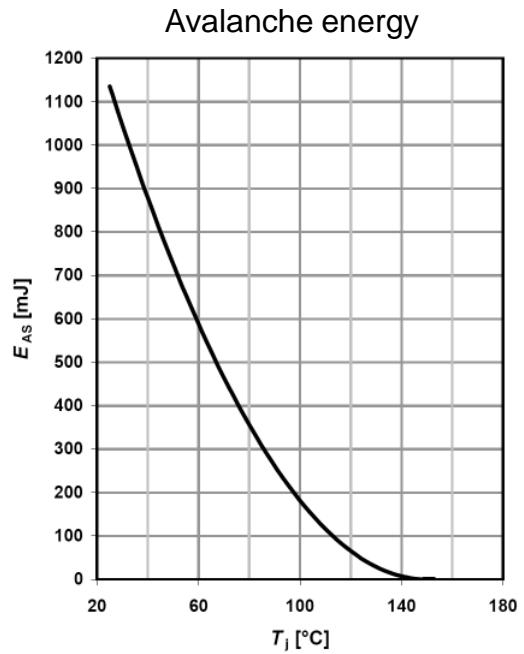


$I_D = f(V_{GS}); V_{DS} = 40\text{ V}$

Typical Performance Characteristics

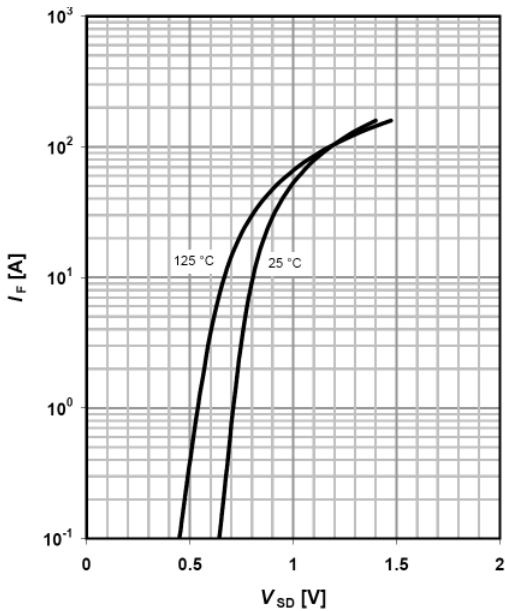


$V_{GS}=f(Q_g), I_D=23A$ pulsed



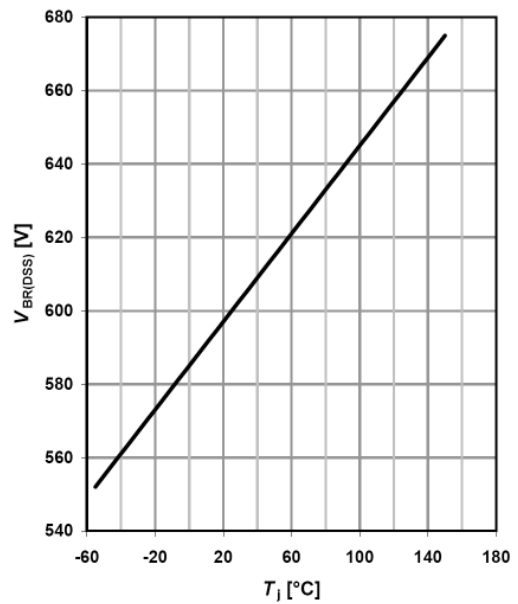
$E_{AS}=f(T_j); I_D=9.3A; V_{DD}=50$ V

Forward characteristics of reverse diode



$I_F=f(V_{SD});$ parameter: T_j

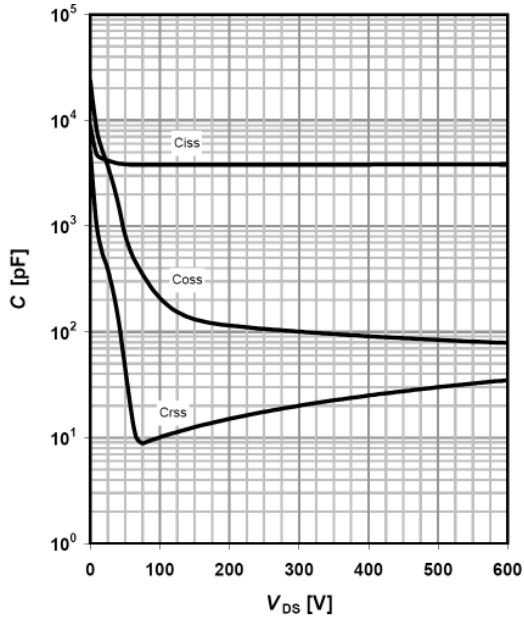
Drain-source breakdown voltage



$V_{BR(DSS)}=f(T_j); I_D=0.25mA$

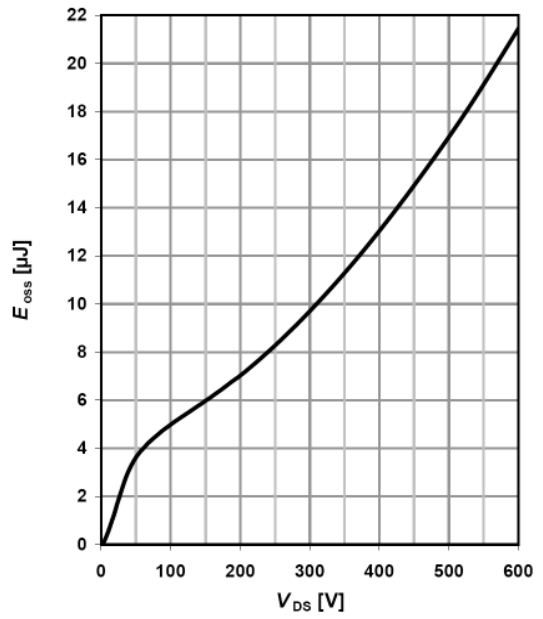
Typical Performance Characteristics

Typ. capacitances



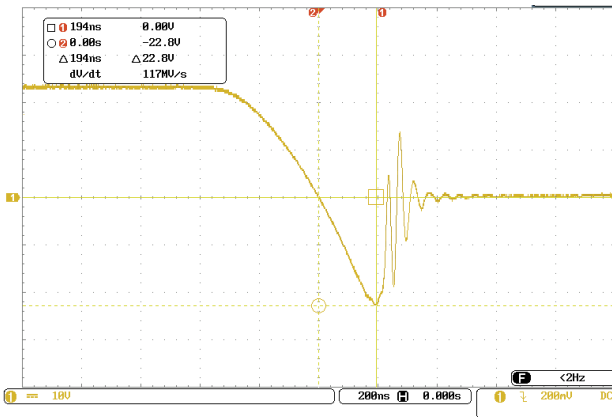
$C=f(V_{DS}); V_{GS}=0\text{ V}; f=1\text{ MHz}$

Typ. Coss stored energy



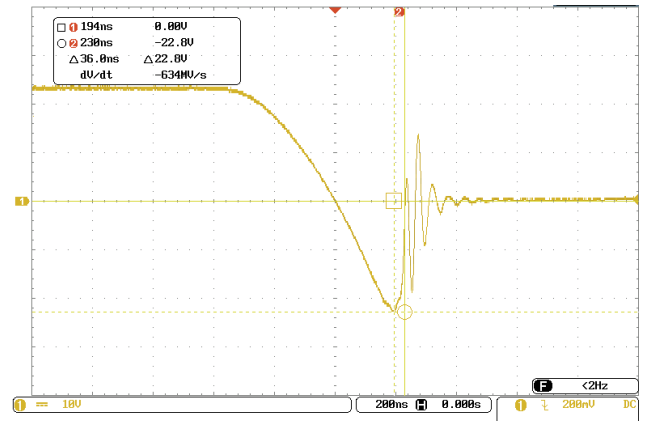
$E_{OSS}=f(V_{DS})$

Typ. Recovery Time(Ts)



$VR=480V, Is = 23A, dI/dt = 100A/\mu s$

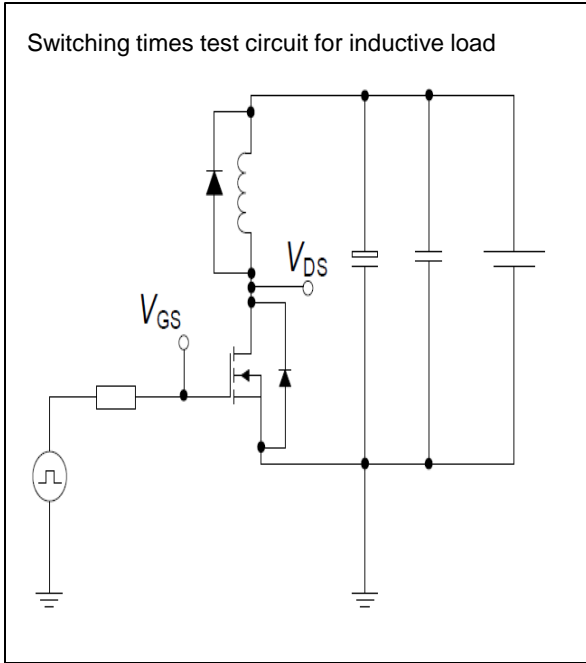
Typ. Recovery Time(Tf)



$VR=480V, Is = 23A, dI/dt = 100A/\mu s$

Test circuits

Switching times test circuit and waveform for inductive load

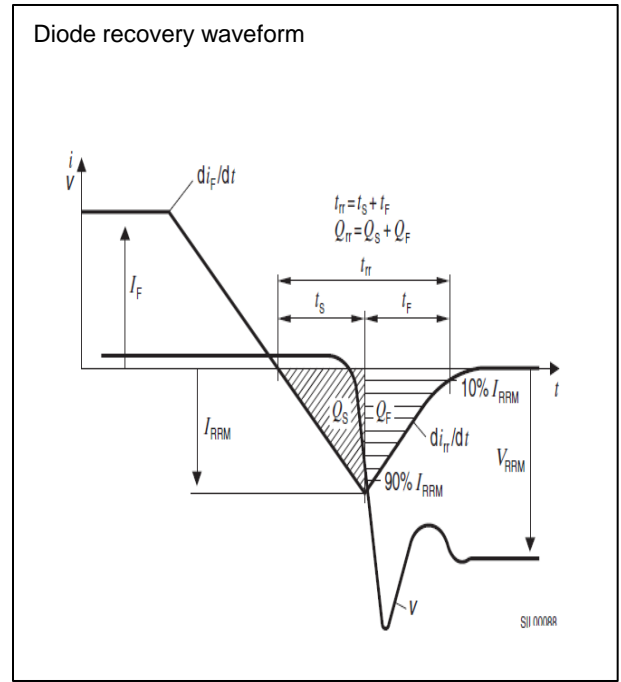
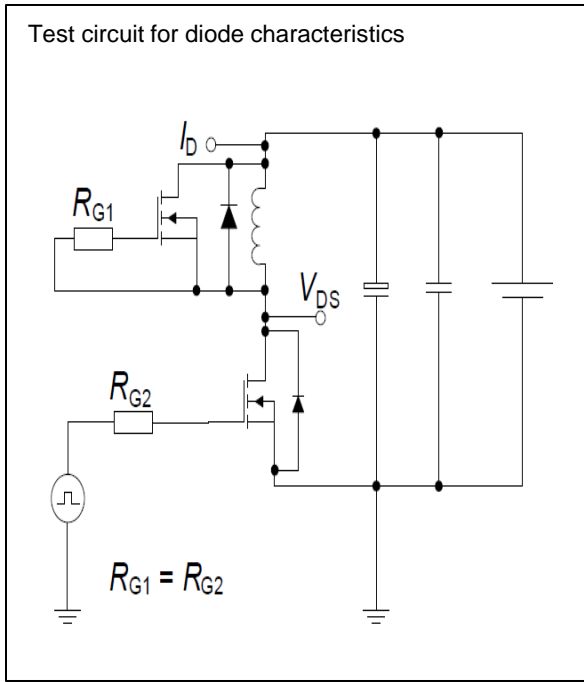


Unclamped inductive load test circuit and waveform



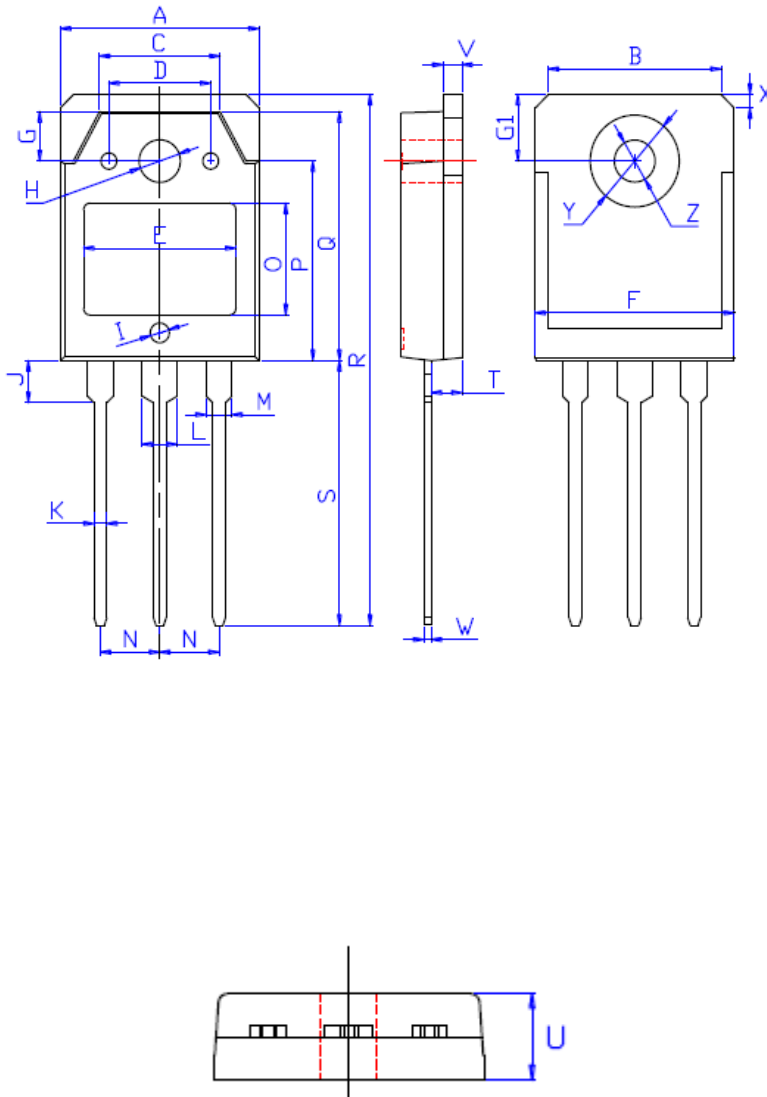
Test circuits

Test circuit and waveform for diode characteristics



Package Outline TO-3P

TS460R070SFD 600V 47A N-Channel SJ-MOSFET



DIM	MILLIMETERS
A	15.60±0.30
B	13.60±0.30
C	9.50±0.30
D	8.00±0.30
E	11.85±0.30
F	15.65±0.30
G	3.80±0.30
G1	5.00±0.30
H	Φ 3.50±0.30
I	Φ 1.50±0.30 深 0.15±0.15
J	3.20±0.30
K	1.00±0.15
L	3.10±0.15
M	2.10±0.15
N	5.45±0.30
O	8.40±0.30
P	13.90±0.30
Q	18.70±0.30
R	40.00±0.60
S	20.00±0.40
T	2.40±0.30
U	4.80±0.30
V	1.50±0.15
W	0.60±0.15
X	1.80±0.40
Y	7.00±0.30
Z	3.20±0.30